

# iC-PN2612

## PHASED ARRAY NONIUS ENCODER

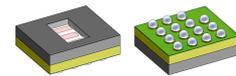
### FEATURES

- ◆ Compact, 3-channel optical nonius encoder with differential scanning and analog sine/cosine outputs:  
511 CPR (N), 512 CPR (M), 496 CPR (S), size  $\varnothing$  26 mm
- ◆ Phased-array design for excellent signal matching
- ◆ Reduced cross talk due to moderate track pitch
- ◆ Ultra low dark currents for operation up to high temperature
- ◆ Low noise amplifiers with high transimpedance gain
- ◆ Short-circuit-proof, low impedance voltage outputs for enhanced EMI tolerance
- ◆ Space saving optoQFN and optoBGA packages (RoHS compliant)
- ◆ Low power consumption from single 4.1 to 5.5 V supply
- ◆ Operational temperature range of -40 to +110 °C
- ◆ Suitable code disc:  
LSHC11S 26-512N (glass 1 mm)  
OD  $\varnothing$  26 mm, ID  $\varnothing$  11.6 mm, optical radius 10.905 mm

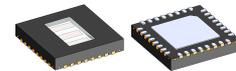
### APPLICATIONS

- ◆ Absolute position encoders

### PACKAGES

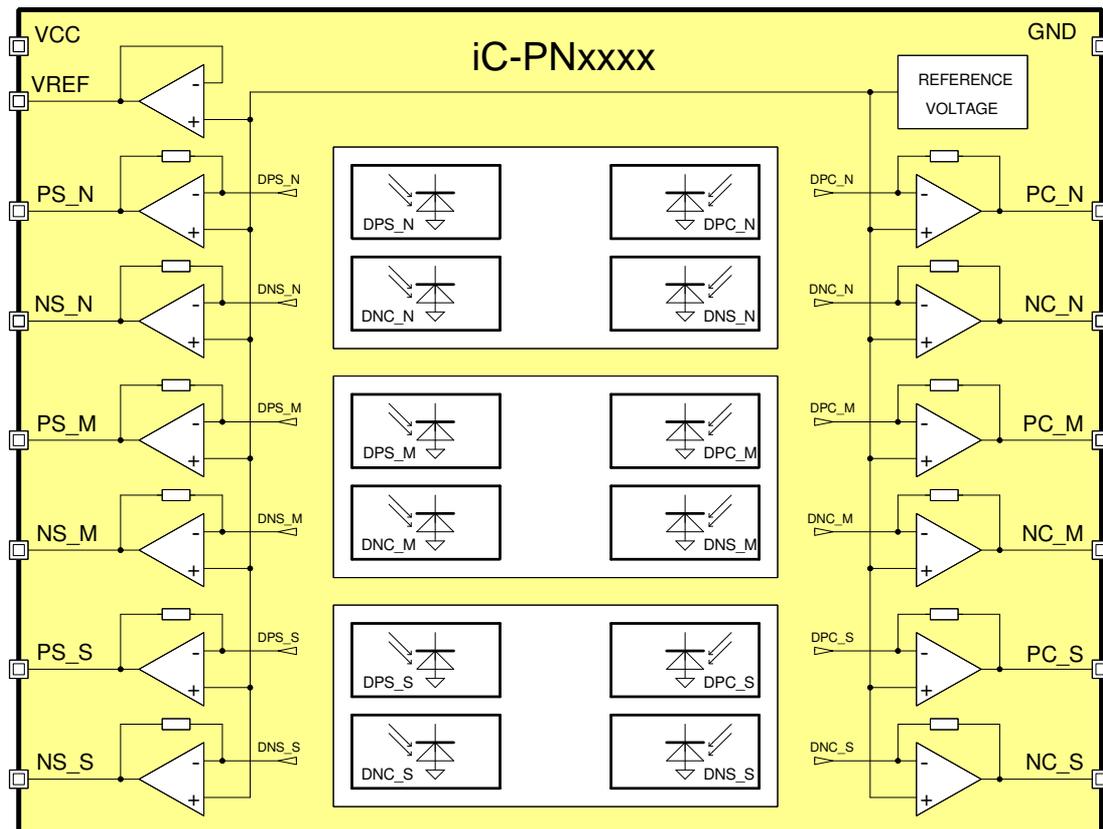


15-pin optoBGA  
6.2 mm x 5.2 mm x 1.7 mm



32-pin optoQFN  
5 mm x 5 mm x 0.9 mm

### BLOCK DIAGRAM



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### DESCRIPTION

The optical encoder iC-PN2612 features monolithically integrated photosensors arranged as a phased-array.

The transimpedance gain of typically  $1\text{ M}\Omega$  generates output signals of a few hundred millivolts already from an illumination level of  $3\text{ mW/cm}^2$ . In most cases no additional measures must be considered to filter for noise and interferences.

Analog nonius encoders are the typical application for iC-PN2612. Its 3-track scanning features a phased-array of multiple photosensors each per

track, generating positive and negative going sine signals, as well as positive and negative going cosine signals. An excellent matching and common mode behavior of the differential signal paths is obtained by a paired amplifier design, reducing the needs for external signal calibration to an absolute minimum.

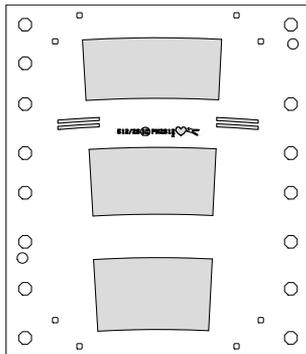
**HD Phased Arrays** are designed for fidelity and robustness. Ultra-low signal distortion is obtained at increased tolerances for alignment and random code defects (e.g. due to dust).

For information on chip releases, refer to chapter Design Review.

### PACKAGING INFORMATION INFORMATION

#### PAD LAYOUT

Chip release Z (2.88 mm x 3.37 mm)



#### PAD FUNCTIONS

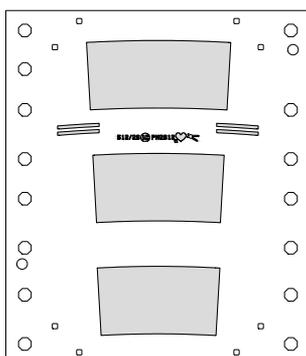
No. Name Function

Refer to the description of pin functions.

Grey sections represent sensor layout areas; fill factors vary.

#### PAD LAYOUT

Chip release Y1 (2.88 mm x 3.37 mm),  
**HD Phased Array**



#### PAD FUNCTIONS

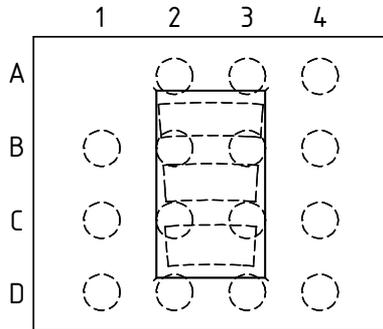
No. Name Function

# iC-PN2612

## PHASED ARRAY NONIUS ENCODER

### PIN CONFIGURATION

oBGA LSH2C (6.2 mm x 5.2 mm)



### PIN FUNCTIONS

No. Name Function

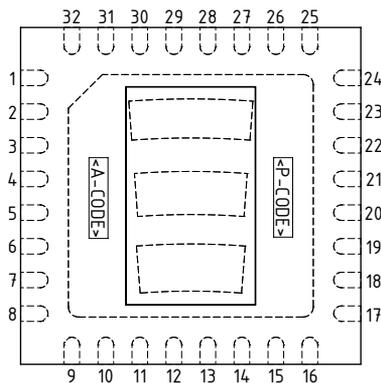
|    |      |             |                          |
|----|------|-------------|--------------------------|
| A2 | VCC  | +4.1..5.5 V | Supply Voltage           |
| A3 | VREF |             | Reference Voltage Output |
| A4 | GND  |             | Ground                   |
| B1 | PS_N |             | N-Track Sine +           |
| B2 | NS_N |             | N-Track Sine -           |
| B3 | NC_N |             | N-Track Cosine -         |
| B4 | PC_N |             | N-Track Cosine +         |
| C1 | PS_M |             | M-Track Sine +           |
| C2 | NS_M |             | M-Track Sine -           |
| C3 | NC_M |             | M-Track Cosine -         |
| C4 | PC_M |             | M-Track Cosine +         |
| D1 | PS_S |             | S-Track Sine +           |
| D2 | NS_S |             | S-Track Sine -           |
| D3 | NC_S |             | S-Track Cosine -         |
| D4 | PC_S |             | S-Track Cosine +         |

Note: All signal outputs are analog voltage outputs.

For dimensional specifications refer to the relevant package data sheet, available separately.

### PIN CONFIGURATION

oQFN32-5x5 (5 mm x 5 mm)



### PIN FUNCTIONS

No. Name Function

|        |                    |             |                               |
|--------|--------------------|-------------|-------------------------------|
| 1      | VCC                | +4.1..5.5 V | Supply Voltage                |
| 2      | VREF               |             | Reference Voltage Output      |
| 3      | PS_N               |             | N-Track Sine +                |
| 4      | NS_N               |             | N-Track Sine -                |
| 5      | PS_M               |             | M-Track Sine +                |
| 6      | NS_M               |             | M-Track Sine -                |
| 7      | PS_S               |             | S-Track Sine +                |
| 8      | NS_S               |             | S-Track Sine -                |
| 9..16  | n.c. <sup>1)</sup> |             |                               |
| 17     | NC_S               |             | S-Track Cosine -              |
| 18     | PC_S               |             | S-Track Cosine +              |
| 19     | NC_M               |             | M-Track Cosine -              |
| 20     | PC_M               |             | M-Track Cosine +              |
| 21     | NC_N               |             | N-Track Cosine -              |
| 22     | PC_N               |             | N-Track Cosine +              |
| 24     | GND                |             | Ground                        |
| 25..32 | n.c. <sup>1)</sup> |             |                               |
| BP     |                    |             | Backside paddle <sup>2)</sup> |

Note: All signal outputs are analog voltage outputs.

IC top marking: <P-CODE> = product code, <A-CODE> = assembly code (subject to changes);

1) Pin numbers marked n.c. are not connected.

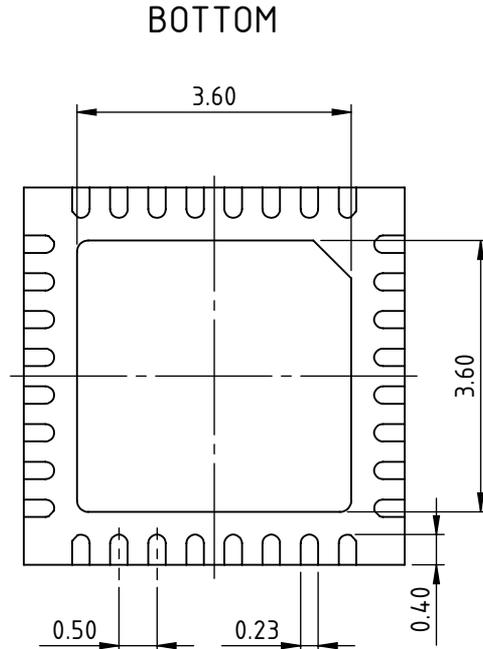
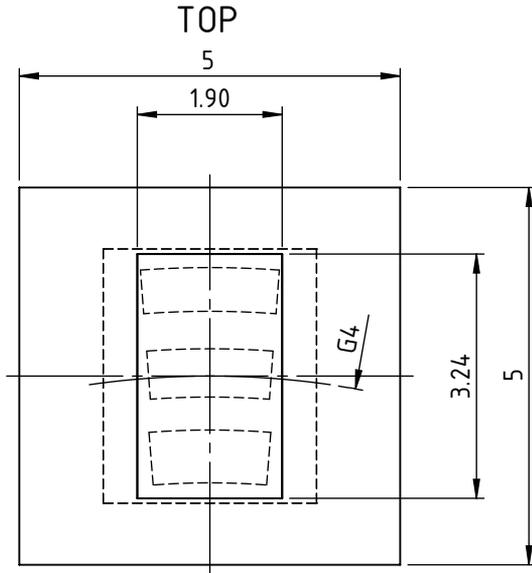
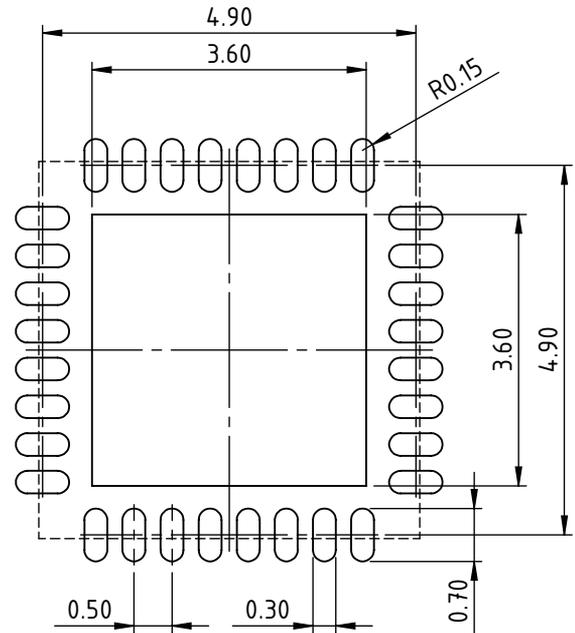
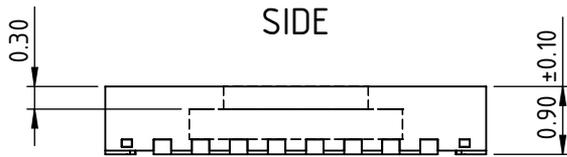
2) Connecting the backside paddle is recommended by a single link to GND. A current flow across the paddle is not permissible.

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### PACKAGE DIMENSIONS oQFN32-5x5

### RECOMMENDED PCB-FOOTPRINT



All dimensions given in mm. Tolerances of form and position according to JEDEC MO-220.  
 Positional tolerance of sensor pattern:  $\pm 70\mu\text{m}$  /  $\pm 1^\circ$  (with respect to backside pad).  
 G4: radius of chip center (refer to the relevant encoder disc and code description).  
 Maximum molding excess  $+20\mu\text{m}$  /  $-75\mu\text{m}$  versus surface of glass/reticle.

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### ABSOLUTE MAXIMUM RATINGS

These ratings do not imply operating conditions; functional operation is not guaranteed. Beyond these ratings device damage may occur.

| Item No. | Symbol | Parameter                       | Conditions                            |      |           | Unit |
|----------|--------|---------------------------------|---------------------------------------|------|-----------|------|
|          |        |                                 |                                       | Min. | Max.      |      |
| G001     | VCC    | Voltage at VCC                  |                                       | -0.3 | 6         | V    |
| G002     | I(VCC) | Current in VCC                  |                                       | -20  | 20        | mA   |
| G003     | V()    | Pin Voltage, all signal outputs |                                       | -0.3 | VCC + 0.3 | V    |
| G004     | I()    | Pin Current, all signal outputs |                                       | -20  | 20        | mA   |
| G005     | Vd()   | ESD Susceptibility, all pins    | HBM, 100 pF discharged through 1.5 kΩ |      | 2         | kV   |
| G006     | Tj     | Junction Temperature            |                                       | -40  | 150       | °C   |
| G007     | Ts     | Chip Storage Temperature        |                                       | -40  | 150       | °C   |

### THERMAL DATA

Operating conditions: VCC = 4.1...5.5 V

| Item No. | Symbol | Parameter                           | Conditions  | Min. | Typ. | Max. | Unit |
|----------|--------|-------------------------------------|---|------|------|------|------|
|          |        |                                     |   |      |      |      |      |
| T01      | Ta     | Operating Ambient Temperature Range | package oQFN32-5x5<br>package oBGA LSH2C<br><br>(extended temperature range on request)   | -40  |      | 110  | °C   |
|          |        |                                     |   | -40  |      | 110  | °C   |
| T02      | Ts     | Storage Temperature Range           | package oQFN32-5x5<br>package oBGA LSH2C  | -40  |      | 110  | °C   |
| T03      | Tpk    | Soldering Peak Temperature          | package oQFN32-5x5<br><br>tpk < 20 s, convection reflow<br>tpk < 20 s, vapor phase soldering<br><br>MSL 5A (max. floor live 24 h at 30 °C and 60 % RH);<br>Please refer to customer information file No. 7 for details. |      |      | 245  | °C   |
|          |        |                                     |   |      |      | 230  | °C   |
| T04      | Tpk    | Soldering Peak Temperature          | package oBGA LSH2C<br><br>tpk < 20 s, convection reflow<br>tpk < 20 s, vapor phase soldering<br><br>TOL (time on label) 8 h;<br>Please refer to customer information file No. 7 for details.                            |      |      | 245  | °C   |
|          |        |                                     |   |      |      | 230  | °C   |

All voltages are referenced to ground unless otherwise stated.

All currents flowing into the device pins are positive; all currents flowing out of the device pins are negative.

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## PHASED ARRAY NONIUS ENCODER



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### ELECTRICAL CHARACTERISTICS

Operating conditions: VCC = 4.1...5.5 V, Tj = -40...125 °C, unless otherwise stated

| Item No.                       | Symbol             | Parameter   | Conditions   |              |              |              | Unit   |
|--------------------------------|--------------------|---|--|--------------|--------------|--------------|--|
|                                |                    |   |  | Min.         | Typ.         | Max.         |  |
| <b>Total Device</b>            |                    |   |  |              |              |              |  |
| 001                            | VCC                | Permissible Supply Voltage                            |  | 4.1          |              | 5.5          | V  |
| 002                            | I(VCC)             | Supply Current in VCC                                 | no load, photocurrents within linear op. range (no override)   |              | 9.5          | 15           | mA   |
| 003                            | Vc()hi             | Clamp-Voltage hi at all pins                          | I() = 4 mA   |              |              | 11           | V  |
| 004                            | Vc()lo             | Clamp-Voltage lo at all pins                          | I() = -4 mA  | -1.2         |              | -0.3         | V  |
| <b>Photosensors</b>            |                    |   |  |              |              |              |  |
| 101                            | $\lambda_{ar}$     | Spectral Application Range                            | $Se(\lambda_{ar}) = 0.25 \times S(\lambda_{pk})$   | 400          |              | 950          | nm   |
| 102                            | $\lambda_{pk}$     | Peak Sensitivity Wavelength                           |  |              | 680          |              | nm   |
| 103                            | Aph()              | Radiant Sensitive Area                                | chip release PN2612_Z<br>chip release PN2612_Y1  |              | 0.08<br>0.13 |              | mm <sup>2</sup><br>mm <sup>2</sup>               |
| 104                            | S( $\lambda$ )     | Spectral Sensitivity                                  | $\lambda_{LED} = 740$ nm<br>$\lambda_{LED} = 850$ nm   |              | 0.5<br>0.3   |              | A/W<br>A/W                                       |
| 106                            | E()mxr             | Irradiance For Maximum Signal Level                   | $\lambda_{LED} = 740$ nm, Vout() not saturated;<br>chip release PN2612_Z<br><br>chip release PN2612_Y1 |              | 9.3<br>4.4   |              | mW/<br>cm <sup>2</sup><br>mW/<br>cm <sup>2</sup> |
| <b>Photocurrent Amplifiers</b> |                    |   |  |              |              |              |  |
| 201                            | Iph()              | Permissible Photocurrent Operating Range              |  | 0            |              | 1120         | nA   |
| 202                            | $\eta()$ r         | Photo Sensitivity (light-to-voltage conversion ratio) | $\lambda_{LED} = 740$ nm;<br>chip release PN2612_Z<br>chip release PN2612_Y1                           | 0.2          | 0.27<br>0.3  | 0.5          | V/ $\mu$ W<br>V/ $\mu$ W                         |
| 203                            | Z()                | Equivalent Transimpedance Gain                        | $Z = Vout() / Iph()$   | 0.7          | 1.0          | 1.4          | M $\Omega$                                       |
| 204                            | TCz                | Temperature Coefficient of Transimpedance Gain        |  |              | -0.12        |              | %/°C   |
| 209                            | $\Delta Z()$ pn    | Transimpedance Gain Matching                          | P. channel vs. corresponding N.. channel   | -0.2         |              | 0.2          | %  |
| 210                            | $\Delta Vout()$ pn | Signal Matching                                       | no illumination, any output vs. any output   | -35          |              | 35           | mV   |
| 211                            | $\Delta Vout()$ pn | Signal Matching                                       | no illumination, P.. output vs. corresponding N.. output   | -2.5         |              | 2.5          | mV   |
| 212                            | fc()hi             | Cut-off Frequency (-3 dB)                             |  |              | 400          |              | kHz  |
| 213                            | VNoise()           | RMS Output Noise                                      | illuminated to 500 mV signal level above dark level, 500 kHz band width                                |              | 0.5          |              | mV   |
| <b>Signal Outputs</b>          |                    |   |  |              |              |              |  |
| 301                            | Vout()mx           | Permissible Maximum Output Voltage                    | illumination to E()mxr, linear gain;<br>VCC = 4.5...5.5 V<br>VCC = 4.1 V                               | 2.45<br>2.05 | 2.72<br>2.3  | 3.02<br>2.6  | V<br>V   |
| 302                            | Vout()d            | Dark Signal Level                                     | no illumination, load 20 k $\Omega$ vs. +2 V   | 575          | 770          | 1000         | mV   |
| 303                            | Vout()acmx         | Maximum Signal Level                                  | $Vout()acmx = Vout()mx - Vout()d$ ;<br>VCC = 4.5...5.5 V<br>VCC = 4.1 V                                | 1.48<br>1.18 | 1.96         | 2.35<br>2.35 | V<br>V   |
| 304                            | Isc()hi            | Short-Circuit Current hi                              | load current to ground   | 100          | 420          | 1000         | $\mu$ A  |
| 305                            | Isc()lo            | Short-Circuit Current lo                              | load current to IC   | 250          | 480          | 700          | $\mu$ A  |
| 306                            | Ri()               | Internal Output Resistance                            | f = 1 kHz  | 70           | 110          | 180          | $\Omega$   |
| 307                            | ton()              | Power-On Settling Time                                | VCC = 0 V $\rightarrow$ 5 V  |              |              | 100          | $\mu$ s  |
| <b>Reference Voltage VREF</b>  |                    |   |  |              |              |              |  |
| 401                            | VREF               | Reference Voltage                                     | I(VREF) = -100...+300 $\mu$ A  | 575          | 770          | 1000         | mV   |
| 402                            | dVout()            | Load Balancing  | I(VREF) = -100...+300 $\mu$ A  | -10          |              | +10          | mV   |
| 403                            | Isc()hi            | Short-Circuit Current hi                              | load current to ground   | 200          | 420          | 1400         | $\mu$ A  |
| 404                            | Isc()lo            | Short-Circuit Current lo                              | load current to IC   | 0.5          | 4.5          | 10           | mA   |

# iC-PN2612

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### APPLICATION CIRCUITS

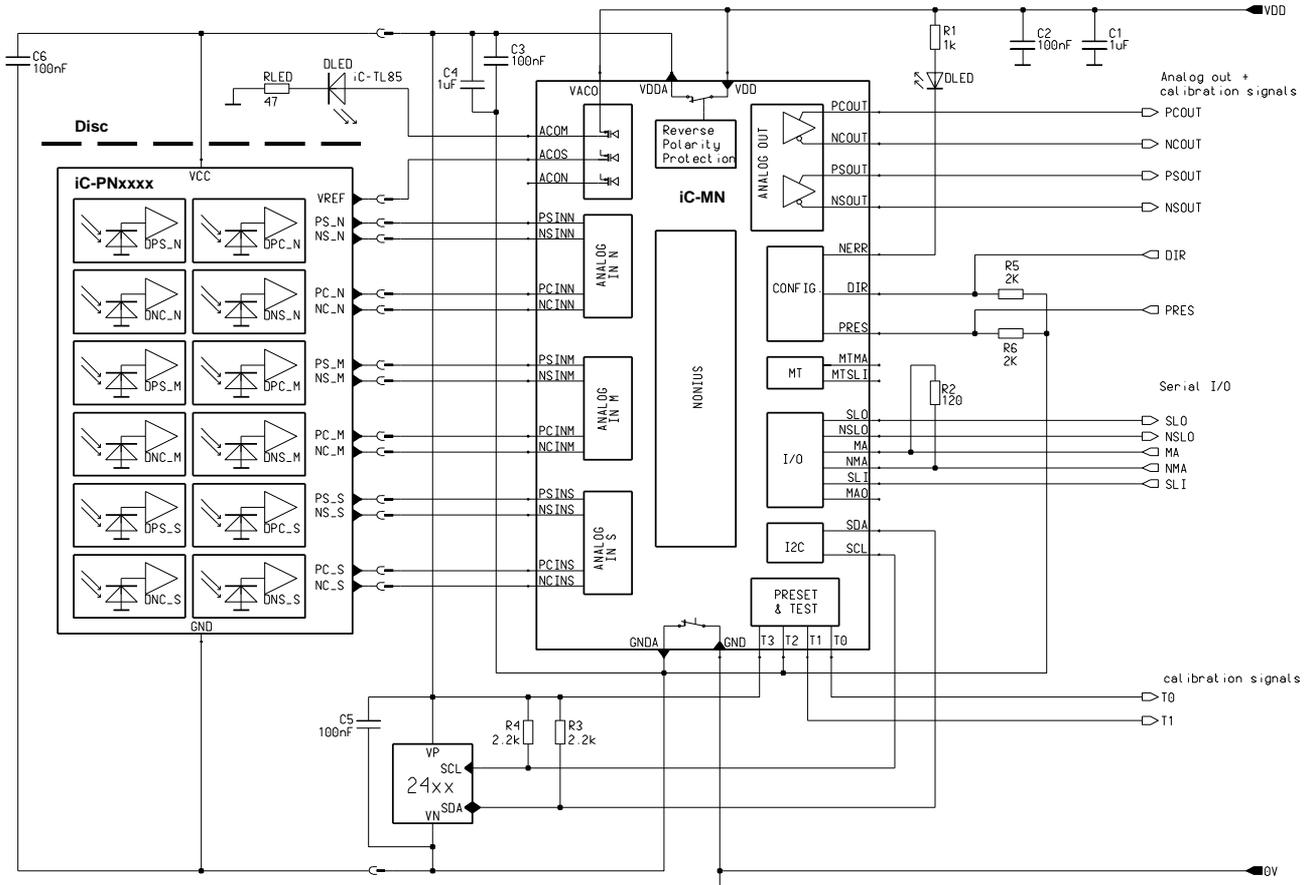


Figure 1: Application example of absolute encoder circuit.

# iC-PN2612

## PHASED ARRAY NONIUS ENCODER



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### DESIGN REVIEW: Notes On Chip Functions

| iC-PN2612 Z |                          |   |
|-------------|--------------------------|---|
| No.         | Function, Parameter/Code | Description and Application Hints   |
| 1           |                          | None at time of printing (datasheet release B2, 2011).<br>Changes to Elec. Char. are documented by this datasheet release, including the extension of operating voltage down to 4.1 V (safe by design). |

Table 4: Notes on chip functions regarding iC-PN2612 chip release Z

| iC-PN2612 Y1 |                          |  |
|--------------|--------------------------|--|
| No.          | Function, Parameter/Code | Description and Application Hints  |
| 1            | <i>HD Phased Array</i>   | Chip release utilizes a high density phased array layout.<br>Improvement of alignment marks: enlarged radial size, inner ring omitted. |

Table 5: Notes on chip functions regarding iC-PN2612 chip release Y1.

### REVISION HISTORY

| Rel | Rel.Date | Chapter | Modification | Page |
|-----|----------|---------|--------------|------|
| B2  | 11-07-14 | ...     |              |      |

| Rel | Rel.Date | Chapter                                | Modification   | Page |
|-----|----------|--|--|------|
| C1  | 14-09-05 | FEATURES                               | Supply voltage extended to include 4.1 V   | 1    |
|     |          | DESCRIPTION                            | Description of <i>HD Phased Array</i> supplemented   | 2    |
|     |          | PACKAGING INFORMATION                  | Chip release Y1 supplemented,<br>oQFN package drawings updated for top marking and tolerances  | 2, 3 |
|     |          | THERMAL DATA                           | Package qualification pending removed  | 3    |
|     |          | ELECTRICAL CHARACTERISTICS             | Operating conditions: VCC supply voltage extended to include 4.1 V<br>Item 001: min. limit; item 101, condition: reference is $\lambda$ pk;<br>Items 103, 106, 202: update of values for Z and Y1 chip releases<br>Items 301, 303: conditions and limits for 4.1 V;<br>Item 302, 401: min. limit; item 304, 403: max. limit; | 6    |
|     |          | APPLICATION CIRCUITS                   | Application example corrected  | 7    |
|     |          | DESIGN REVIEW: Notes On Chip Functions | Chapter supplemented   | 8    |
|     |          | ORDERING INFORMATION                   | Update of P/O codes and items  | 9    |

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### ORDERING INFORMATION

| Type           | Package  | Options  | Order Designation    |
|----------------|--|--|----------------------|
| iC-PN2612      | 32-pin optoQFN,<br>5 mm x 5 mm,<br>thickness 0.9 mm<br>RoHS compliant    |  | iC-PN2612 oQFN32-5x5 |
|                | 15-pin optoBGA,<br>6.2 mm x 5.2 mm<br>thickness 1.7 mm<br>RoHS compliant |  | iC-PN2612 oBGA LSH2C |
| Evaluation Kit | PCB (60 mm x 40 mm),<br>assembled with optoQFN                           | with LED and code disc   | iC-PN2612 EVAL PNH1M |
|                | PCB (60 mm x 40 mm),<br>assembled with optoBGA                           | with LED and code disc   | iC-PN2612 EVAL LSH2M |
| Code Disc      |  | 511/512/496 PPR<br>OD $\varnothing$ 26 mm, ID $\varnothing$ 11.6 mm,<br>optical radius 10.905 mm<br>(glass 1 mm) | LSHC11S 26-512N      |

For technical support, information about prices and terms of delivery please contact:

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